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11-17-02
Docket No. 219.40430X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: H. XIE, et al. ✓

Serial No.: 09/964,494 ✓

Filed: September 28, 2001 ✓

For: ARRANGEMENTS TO INCREASE STRUCTURAL RIGIDITY OF SEMICONDUCTOR PACKAGE ✓

Art Unit: 2811

Examiner: UNKNOWN

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PRELIMINARY AMENDMENT

COMMISSIONER OF PATENTS
Washington, DC 20231

March 19, 2002

Sir:

The following preliminary amendments and remarks are respectfully submitted in connection with the above-identified application.

IN THE CLAIMS:

Please amend claims 1-2, 5-6, 8-11, 13-18, 21-22, 24-27, 31-34, 37-38, 40-43, 47-49 and add new claims 50-62 as follows. Note that the full text of all claims (including those not being amended within this paper) may also be included to provide the convenience of a complete set of claims for easy review:

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414.00 OP

11/19/2002 TBELL 00000004 0121125 09964494
File Ref: 00000004
02 FC:1201
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